

/ Descriptions

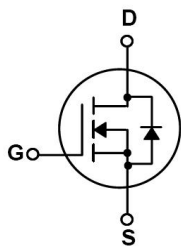
/ Features

/ /

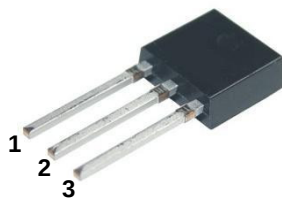
/ Applications

GF2GF

/ Equivalent Circuit



/ Pinning



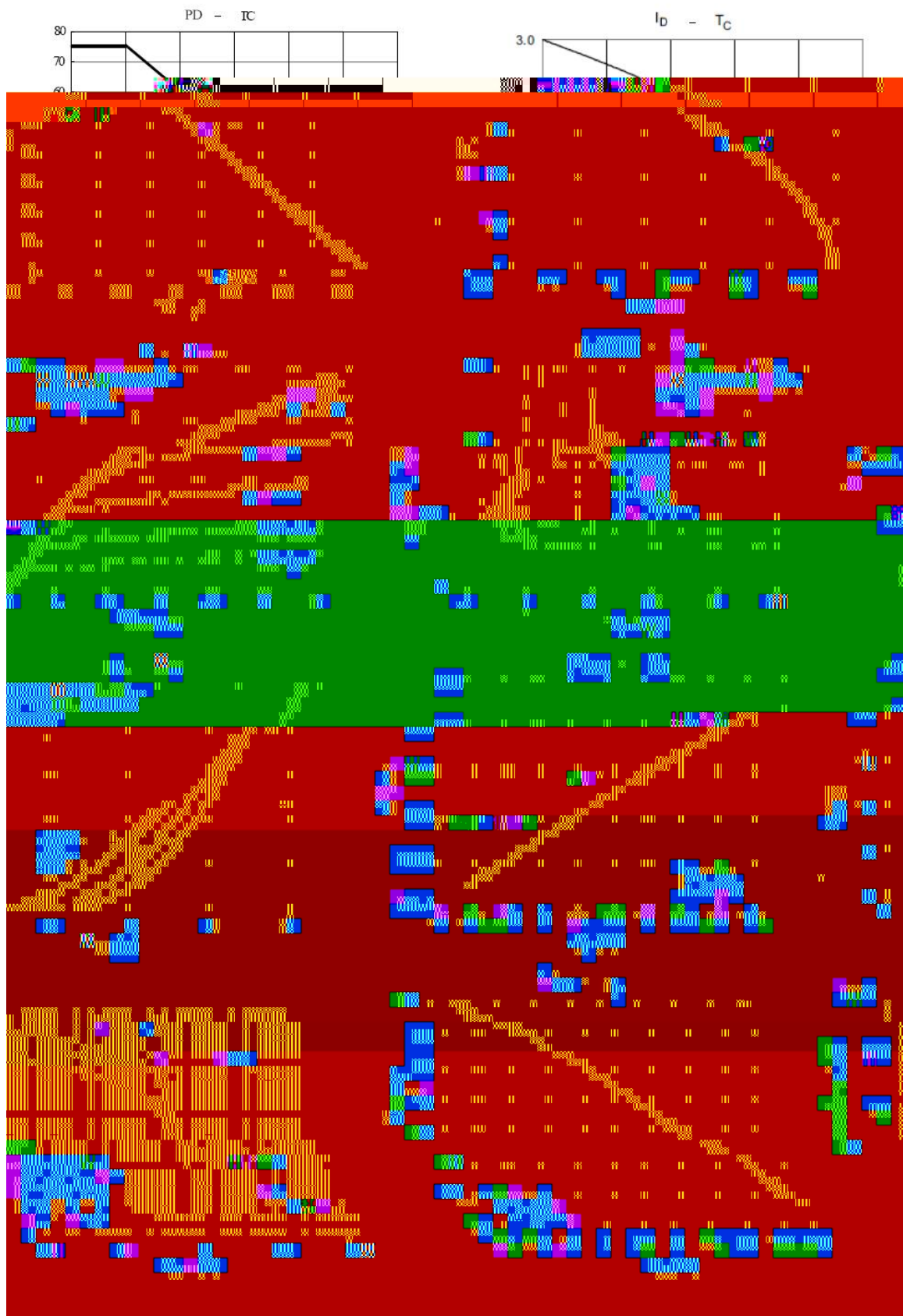
/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

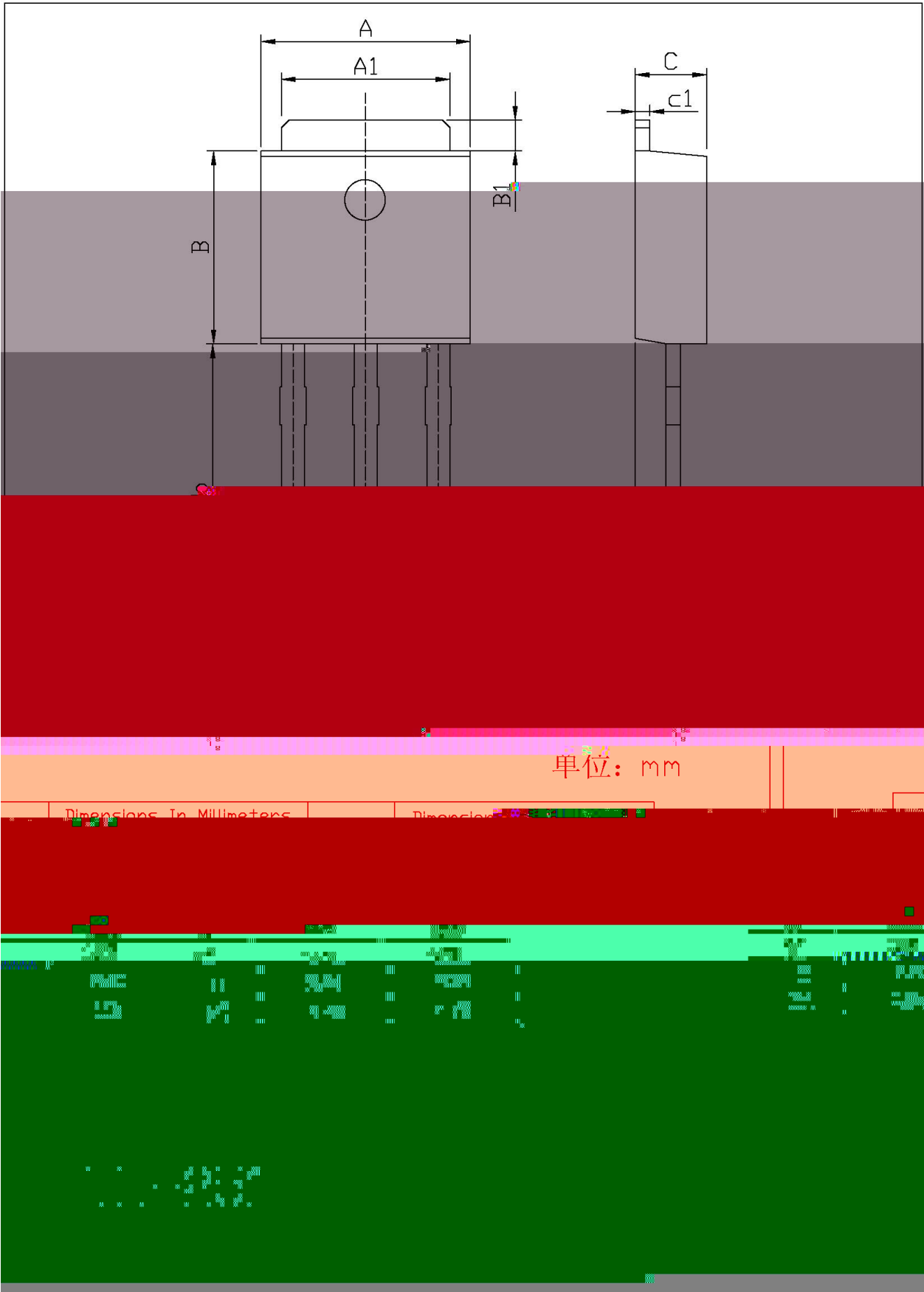
/ Electrical Characteristics(Ta=25)

		μ				
						μ
						μ
						μ
		μ				
						Ω
		Ω				

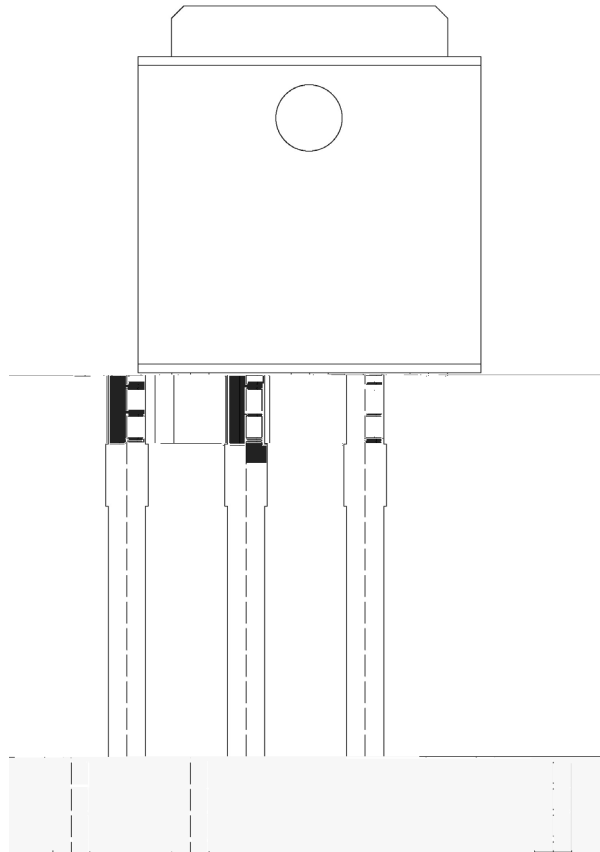
/ Electrical Characteristic Curve



/ Package Dimensions

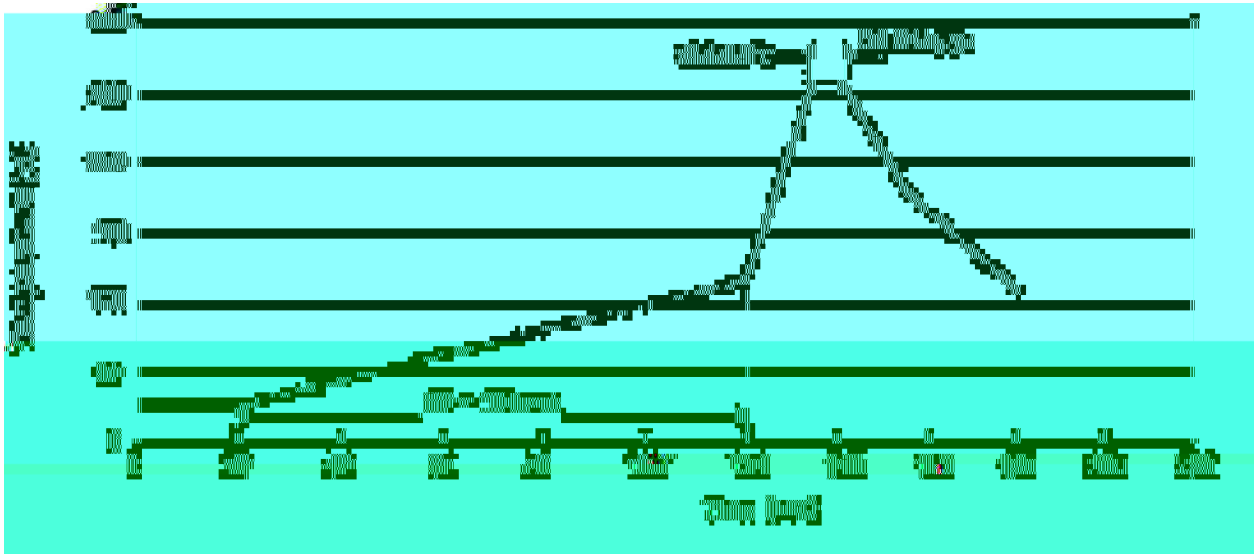


/ Marking Instructions



6Q;3

() / Temperature Profile for Dip Soldering(Pb-Free)



$\frac{3}{8}$

2 $\frac{3}{8}$

$\frac{3}{8}$

2

$\frac{3}{8}$

2 $\frac{3}{8}$

$\frac{3}{8}$

2

/ Resistance to Soldering Heat Test Conditions

2 $\frac{3}{8}$

2

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 袋	袋 盒	只 盒	盒 箱	只 箱	袋	盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices